



Bib Data Sheet


**UNITED STATES DEPARTMENT OF COMMERCE**  
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<b>SERIAL NUMBER</b> 09/501,622	<b>FILING DATE</b> 02/09/2000 <b>RULE</b> -	<b>CLASS</b> 438	<b>GROUP ART UNIT</b> 2812	<b>ATTORNEY DOCKET NO.</b> 8ac4-D2
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**APPLICANTS**

Randell L. Mills, Yardley, PA ;

**\*\* CONTINUING DATA \*\*\*\*\***

THIS APPLICATION IS A DIV OF 09/111,003 07/07/1998  
 WHICH CLAIMS BENEFIT OF 60/053,378 07/22/1997  
 AND CLAIMS BENEFIT OF 60/068,913 12/29/1997  
 AND CLAIMS BENEFIT OF 60/074,006 02/09/1998  
 AND CLAIMS BENEFIT OF 60/080,647 04/03/1998

**\*\* FOREIGN APPLICATIONS \*\*\*\*\***
**IF REQUIRED, FOREIGN FILING LICENSE GRANTED** \*\* SMALL ENTITY \*\*  
 \*\* 04/06/2000

Foreign Priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no	<b>STATE OR COUNTRY</b> PA	<b>SHEETS DRAWING</b> 89	<b>TOTAL CLAIMS</b> 265	<b>INDEPENDENT CLAIMS</b> 2
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged	Examiner's Signature	Initials		

**ADDRESS**

02736 20736

**TITLE** DOPED SEMICONDUCTOR AND METHOD OF MAKING A DOPED SEMICONDUCTOR  
~~Doped semiconductor and method of making a doped semiconductor~~

<b>FILING FEE RECEIVED</b> 2550	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees
		<input type="checkbox"/> 1.16 Fees ( Filing )
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		<input type="checkbox"/> 1.18 Fees ( Issue )
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